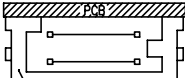


PRODUCT NO. *95706-XXX	STAND OFF DIM"M"(mm)	SOLDER TAIL	DIM "P" (mm)	SHEET NO.	MOUNTING STYLE TO PCB	
000	0	R/A	2.8	NO.2	TOP MOUNT 95706-0XX BLACK COLOR 	
000LF	0	R/A	2.8			
001	0	SMT STAGGERED	—//—			
002	0	SMT IN LINE	—//—			
010	4	R/A	2.8	NO.3		
020	5	R/A	2.8			
040	2	R/A	2.5			
010LF	4	R/A	2.8			
020LF	5	R/A	2.8	NO.4	BOTTOM MOUNT 95706-5XX PCB NATURAL(WHITE)COLOR 	
040LF	2	R/A	2.5			
500	0	R/A	2.8			
500LF	0	R/A	2.8			
501	0	SMT STAGGERED	—//—	NO.5		
502	0	SMT IN LINE	—//—			
510	4	R/A	2.8			
520	5	R/A	2.8			
540	2	R/A	2.5			
510LF	4	R/A	2.8			
520LF	5	R/A	2.8			
540LF	2	R/A	2.5			

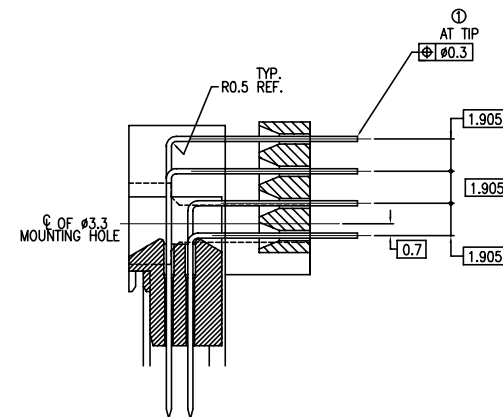
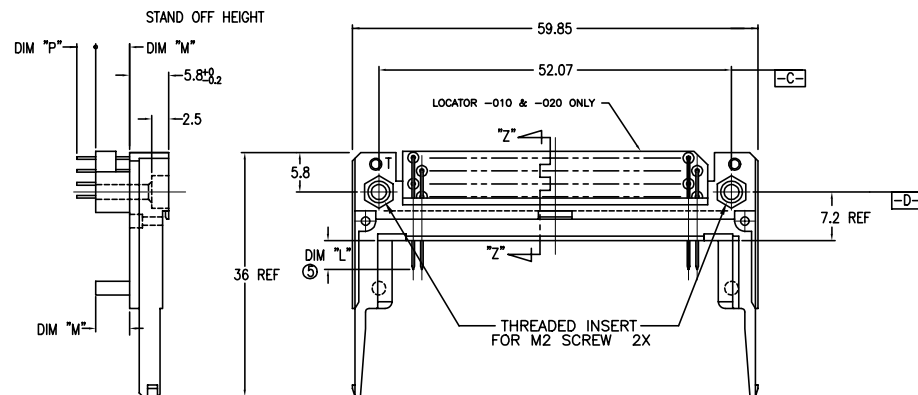
*95706-X X X X
LEAD FREE LF
SOLDER TAIL
STAND OFF
MOUNTING STYLE

0 : R/A (FOR LOWER & SINGLE)
1 : SMT STAGGERED (FOR LOWER ONLY)
2 : SMT IN LINE (FOR LOWER ONLY)
5 : R/A (FOR UPPER ONLY)

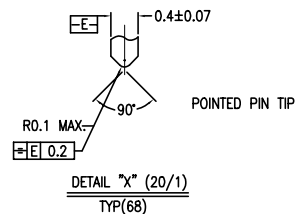
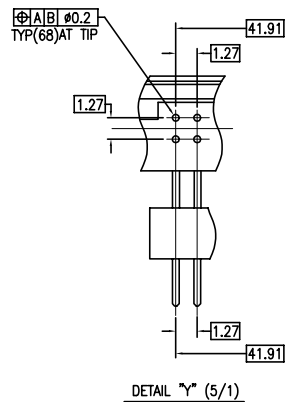
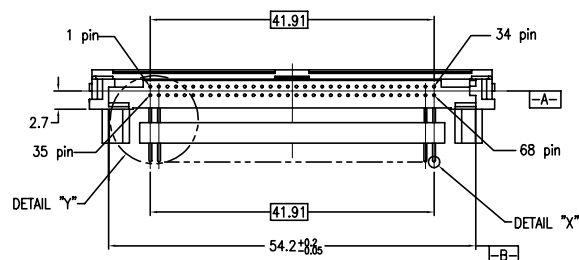
0 : 0mm
1 : 4mm
2 : 5mm
4 : 2mm
0 : TOP MOUNTING
5 : BOTTOM MOUNTING

mat'l. code				surface ISO1302	tolerance ISO1101 ISO406	projection MM	product family MCS
l	tr	ec	n	ndr	date	tolerances unless otherwise specified	title
B	V00619	RGD	3/30/00			0.X±0.3	68 POS. EJECTOR HEADER ASSY. FOR LOW VOLTAGE
C	N05-0048	WB	05/29/03			0.XX±0.13	
D	EX-N-01145	ZK	04/02/12			0.XXX±0.051	
				dr	S.DUESTERHOEF	7/20/95	dwg no 95706 sheet: 1 of 5 size A4
				enr	D.BRANN	7/20/95	
				chr	D.BRANN	7/20/95	
				appd	D.BRANN	7/20/95	type Product Customer Drawing
sheet index	revision	D	D	D	D	D	
	sheet	1	2	3	4	5	

PRODUCT NO.
95706-010/010LF
95706-020/020LF
95706-040/040LF



SECTION "Z"-Z" (5/1)



NOTES

- ① TRUE POSITION IS A FREE GRID TO PIN PATTERN ITSELF.
- ② SEE TA-946 FOR PCB LAYOUT.
- ③ MATERIAL
HOUSING : HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
PIN : PHOSPHOR BRONZE.
- ④ FINISH
PIN
UNDER PLATING : 0.5µm MIN. Ni.
CONTACT AREA : 0.076 µm MIN. GOLD

SOLDER AREA(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
SOLDER AREA(LEAD FREE OPTION): 2.5µm MIN. PURE TIN

⑤ SEQUENCE PIN ASSIGNMENT

	DIM "L"		
	4.25±0.1	3.5±0.1	5.0±0.1
PIN No.	OTHERS	36.67	35.51.68

- 6 GENERAL TOLERANCE : ±0.3
- 7 IF LEAD FREE P/N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE
SOLDER TAIL : SMT-IL, SMT-STG CAN RESIST 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
SOLDER TAIL : R/A CAN RESIST 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- 8 IF LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION
- 9 PRODUCT SPEC:110-263

mat'l. code	surface	tolerance	projection	product family
ISO1302	ISO1101	ISO406	MM	MCS
ltnecn nodr date	tolerances unless otherwise specified			title
D	angle	0.X±0.3	MM	68 POS. EJECTOR HEADER ASSY.
	0°±2'	0.XX±0.13	scale 1:1	FOR LOW VOLTAGE
	0°±2'	0.XXX±0.051		
dr	S.DUESTERHOEF	7/20/95		dwg no
engr	D.BRANN	7/20/95		sheet 3 of 5
chr	D.BRANN	7/20/95		size
appd	D.BRANN	7/20/95		A4
sheet	revision			type
index	sheet			Product Customer Drawing

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